

## **Reinforced, Fast, Low-Power, Six-Channel Digital Isolators**

### **MAX22163–MAX22166**

## **Product Highlights**

- **AEC-Q100 Qualification for /V Devices**
- Reinforced Galvanic Isolation for Digital Signals
	- 16-QSOP with 4mm Creepage and Clearance
	- Withstands  $3kV<sub>RMS</sub>$  for 60s ( $V<sub>ISO</sub>$ )
	- Continuously Withstands  $445V<sub>RMS</sub>$  (V<sub>IOWM</sub>)
	- Withstands ±10kV Surge Between GNDA and GNDB with 1.2/50μs Waveform
	- High CMTI (50kV/μs, typ)
- **Low Power Consumption** 
	- 0.71mW per Channel at 1Mbps with  $V_{DD} = 1.8V$
	- 1.34mW per Channel at 1Mbps with  $V_{DD} = 3.3V$
	- 3.21mW per Channel at 100Mbps with  $V_{DD} = 1.8V$
- Low Propagation Delay and Low Jitter
	- Maximum Data Rate up to 200Mbps
	- Low Propagation Delay 7ns (typ) at  $V_{DD} = 3.3V$
	- Clock Jitter RMS 11.1ps (typ)
- **Safety Regulatory Approvals** 
	- UL According to UL1577
	- cUL According to CSA Bulletin 5A
	- VDE 0884-11 Reinforced Insulation (Pending)

## **Key Applications**

- Automotive
	- Hybrid Electric Vehicle
- Chargers
	- Battery Management System (BMS)
- Inverters

The MAX22163−MAX22166 are a family of six-channel, reinforced, fast, low-power digital galvanic isolators using Analog Devices' proprietary process technology. All devices feature reinforced isolation with a withstand voltage rating of  $3kV<sub>RMS</sub>$  for 60 seconds. Both automotive and general-purpose devices are rated for operation at ambient temperature from -40°C to +125°C.

Devices with /V suffix are AEC-Q100 qualified. See the *[Ordering Information](#page-25-0)* for all automotive grade part numbers.

- Industrial
	- Isolated SPI, RS-232/422/485, CAN, Digital I/O
	- Fieldbus Communications
	- Motor Control
	- Medical Systems

These devices transfer digital signals between circuits with different power domains, using as little as 0.71mW per channel at 1Mbps (1.8V supply). The low-power

## **Simplified Application Diagram**



### **Pin Description**



feature reduces system dissipation, increases reliability, and enables compact designs. Devices are available with a maximum data rate of either 25Mbps or 200Mbps and with default-high or default-low outputs. The devices feature low propagation delay and low clock jitter, which reduces system latency.

Independent 1.71V to 5.5V supplies on each side also make the devices suitable for use as level translators.

The MAX22163 features three channels transmitting digital signals in one direction and three in opposite; the MAX22164 offers four channels transmitting digital signals in one direction and two in opposite; the MAX22165 provides five channels transmitting digital signals in one direction and one in opposite; the MAX22166 features all six channels transmitting digital signals in one direction.

*[Ordering Information](#page-25-0) appears at end of data sheet.*

### <span id="page-1-0"></span>**Absolute Maximum Ratings**





Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or<br>any other conditions beyond those in

### **Package Information**



Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to *[www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial)*.

For the latest package outline information and land patterns (footprints), go to *[www.maximintegrated.com/packages](http://www.maximintegrated.com/packages)*. Note that a "+", "#", or "- " in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

## **DC Electrical Characteristics**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at  $V_{DDA}$  -  $V_{GNDA}$  = 3.3V,  $V_{DDB}$  -  $V_{GNDB}$  = 3.3V,  $V_{GNDA}$  =  $V_{GNDB}$ ,  $T_A$  = +25°C, unless otherwise noted.) (Notes 1, 3)









(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at  $V_{\text{DDA}}$  -  $V_{\text{GNDA}}$  = 3.3V,  $V_{\text{DDR}}$  -  $V_{\text{GNDR}}$  = 3.3V,  $V_{\text{GNDA}}$  =  $V_{\text{GNDA}}$ ,  $T_A$  = +25°C, unless otherwise noted.) (Notes 1, 3)

### **Dynamic Characteristics - MAX2216\_C/F**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at  $V_{\text{DDA}}$  -  $V_{\text{GNDA}}$  = 3.3V,  $V_{\text{DDR}}$  -  $V_{\text{GNDR}}$  = 3.3V,  $V_{\text{GNDA}}$  =  $V_{\text{GNDA}}$ ,  $T_A$  = +25°C, unless otherwise noted.) (Notes 2, 4)





(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at  $V_{\text{DDA}}$  -  $V_{\text{GNDA}}$  = 3.3V,  $V_{\text{DDR}}$  -  $V_{\text{GNDR}}$  = 3.3V,  $V_{\text{GNDA}}$  =  $V_{\text{GNDA}}$ ,  $T_A$  = +25°C, unless otherwise noted.) (Notes 2, 4)

### **Dynamic Characteristics - MAX2216\_B/E**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at  $V_{DDA}$  -  $V_{GNDA}$  = 3.3V,  $V_{DDB}$  –  $V_{GNDB}$  = 3.3V,  $V_{GNDA}$  =  $V_{GNDB}$ ,  $T_A$  = +25°C, unless otherwise noted.) (Notes 2, 4)





(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = 3.3V, V<sub>DDB</sub> – V<sub>GNDB</sub> = 3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Notes 2, 4)

(V<sub>DDA</sub> - V<sub>GNDA</sub> = 1.71V to 5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = 1.71V to 5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at  $V_{DDA}$  -  $V_{GNDA}$  = 3.3V,  $V_{DDB}$  –  $V_{GNDB}$  = 3.3V,  $V_{GNDA}$  =  $V_{GNDB}$ ,  $T_A$  = +25°C, unless otherwise noted.) (Notes 2, 4)

<b>PARAMETER</b>	<b>SYMBOL</b>	<b>CONDITIONS</b>		<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNITS</b>
			$\frac{1.71 \text{V}}{1.71 \text{V}} \leq V_{\text{DD}} \leq$ 1.89V			2.4	
Fall Time (Figure 1)	tF.	$C_L = 5pF$	$4.5V \le V_{DD} \le 5.5V$			1.0	
			$3.0V \le V_{DD}$ ≤ 3.6V			1.4 1.9 3.0	
			$2.25V \le V_{DD} \le$ 2.75V				ns
			$1.71V \le V_{DD} \le$ 1.89V				

**Note 1:** General purpose devices are 100% production tested at  $T_A$  = +25°C. Specifications over temperature are guaranteed by design and characterization. Automotive devices are 100% production tested at  $T_A$  = +25°C and  $T_A$  = +125°C.

- **Note 2:** Not production tested. Guaranteed by design and characterization.
- **Note 3:** All currents into the device are positive. All currents out of the device are negative. All voltages are referenced to their respective grounds (GNDA or GNDB), unless otherwise noted.
- **Note 4:** All measurements are taken with  $V_{DDA} = V_{DDB}$ , unless otherwise noted.
- **Note 5:** CMTI is the maximum sustainable common-mode voltage slew rate while maintaining the correct output. CMTI applies to both rising and falling common-mode voltage edges. Tested with the transient generator connected between GNDA and GNDB ( $V_{CM}$  = 1000V).

### **ESD Protection**



### **Test Circuit and Timing Diagram**



<span id="page-7-0"></span>*Figure 1. Test Circuit (A) and Timing Diagram (B)*



### **Table 1. Insulation Characteristics**

**Note 6:** V<sub>ISO</sub>, V<sub>IOWM</sub>, V<sub>IOTM</sub>, V<sub>IORM</sub>, and V<sub>IOSM</sub> are defined by the IEC 60747-5-5 standard.

**Note 7:** Product is qualified at V<sub>ISO</sub> for 60s and 100% production tested at 120% of V<sub>ISO</sub> for 1s.

**Note 8:** Capacitance is measured with all pins on the A and B sides tied together.

**Note 9:** Devices are immersed in oil during surge characterization.

## **Safety Regulatory Approvals**



The MAX22163−MAX22166 are certified under UL1577. For more details, refer to file E351759.

Rated up to 3000VRMS isolation voltage for single protection.

**cUL (Equivalent to CSA notice 5A)**

The MAX22163−MAX22166 are certified up to 3000V<sub>RMS</sub> for single protection. For more details, refer to file E351759.

#### **VDE (Pending)**

The MAX22163−MAX22166 are certified to DIN VDE V 0884-11: 2017-1. Reinforced Insulation, Maximum Transient Isolation Voltage 4242V<sub>PK</sub>, Maximum Repetitive Peak Isolation Voltage 630V<sub>PK</sub>.

*These couplers are suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.*

## **Typical Operating Characteristics**

( $V_{DDA}$  -  $V_{GNDA}$  = +3.3V,  $V_{DDB}$  -  $V_{GNDB}$  = +3.3V,  $V_{GNDA}$  =  $V_{GNDB}$ ,  $T_A$  = +25°C, unless otherwise noted.)





















 $(V_{DDA} - V_{GNDA} = +3.3V, V_{DDB} - V_{GNDB} = +3.3V, V_{GNDA} = V_{GNDB}, T_A = +25°C$ , unless otherwise noted.)



 $(V_{DDA} - V_{GNDA} = +3.3V, V_{DDB} - V_{GNDB} = +3.3V, V_{GNDA} = V_{GNDB}, T_A = +25°C$ , unless otherwise noted.)







## **Pin Configurations**



# **Pin Descriptions**



# <span id="page-15-0"></span>**Functional Diagrams**





### **Detailed Description**

The MAX22163−MAX22166 are a family of six-channel reinforced digital isolators in a 16-QSOP package, with an isolation rating of 3kV<sub>RMS</sub>. This family of devices offers all possible unidirectional channel configurations to accommodate any six-channel design.

The MAX22163 features three channels transmitting digital signals in one direction and three channels transmitting in the opposite direction for applications such as isolated microcontroller interfaces. The MAX22164 offers four channels transmitting digital signals in one direction and two channels transmitting in the opposite direction, making them ideal for applications such as isolated SPI. The MAX22165 provides five channels transmitting digital signals in one direction and one channel transmitting in the opposite direction. The MAX22166 features all six channels transmitting digital signals in one direction, which are suitable in applications such as isolated digital I/O.

The MAX22163−MAX22166 are available in a 16-pin QSOP package with 4mm creepage and clearance, with an isolation rating of 3kV<sub>RMS</sub>. This family of digital isolators offers low-power operation, high electromagnetic interference (EMI) immunity, and stable temperature performance through Analog Devices' proprietary process technology. The devices isolate different ground domains and block high-voltage/high-current transients from sensitive or human interface circuitry.

Devices are available with a maximum data rate of either 25Mbps (B/E version) or 200Mbps (C/F version). The MAX2216 B/C feature default-high outputs. The MAX2216 E/F feature default-low outputs. The output assumes the default state when the input is not powered or if the input is open-circuit. The MAX22163-MAX22166 have two supply inputs (V<sub>DDA</sub> and V<sub>DDB</sub>) that independently set the logic levels on either side of the device. V<sub>DDA</sub> and V<sub>DDB</sub> are referenced to GNDA and GNDB, respectively. The MAX22163−MAX22166 also feature a refresh circuit to ensure output accuracy when an input remains in the same state indefinitely.

#### **Digital Isolation**

The family of devices provides reinforced galvanic isolation for digital signals transmitted between two ground domains. The MAX22163-MAX22166 can withstand differences of up to 3kVRMS for up to 60 seconds, and up to 630VPEAK of continuous isolation.

#### **AEC-Q100 Qualification**

Devices with /V suffix are AEC-Q100 qualified. See the *[Ordering Information](#page-25-0)* table for all automotive grade part numbers.

#### **Level Shifting**

The wide supply voltage range of both V<sub>DDA</sub> and V<sub>DDB</sub> allows the MAX22163−MAX22166 to be used for level translation in addition to isolation. V<sub>DDA</sub> and V<sub>DDB</sub> can be independently set to any voltage from 1.71V to 5.5V. The supply voltage sets the logic level on the corresponding side of the isolator.

#### **Unidirectional Channels**

Each channel of the device is unidirectional; it only passes data in one direction, as indicated in the *[Functional Diagrams](#page-15-0)*. All devices feature six unidirectional channels that operate independently with guaranteed data rates from DC to 25Mbps (B/E version), or from DC to 200Mbps (C/F version). The output driver of each channel is push-pull, eliminating the need for pullup resistors. The outputs are able to drive both TTL and CMOS logic inputs.

#### **Startup and Undervoltage Lockout**

The V<sub>DDA</sub> and V<sub>DDB</sub> supplies are both internally monitored for undervoltage conditions. Undervoltage events can occur during power-up, power-down, or normal operation due to a sagging supply voltage. When an undervoltage condition is detected on either supply, all outputs go to their default states regardless of the state of the inputs, as seen in *[Table 2](#page-18-0)*. *[Figure 2](#page-18-1)* through *[Figure 5](#page-18-2)* show the behavior of the outputs during power-up and power-down.

# <span id="page-18-0"></span>**Table 2. Output Behavior During Undervoltage Conditions**



*Note: 'X' is don't care.*



<span id="page-18-1"></span>*Figure 2. Undervoltage Lockout Behavior, MAX2216\_B/C, Inputs Figure 3. Undervoltage Lockout Behavior, MAX2216\_E/F, Inputs Set to High Set to High*





*Figure 4. Undervoltage Lockout Behavior, MAX2216\_B/C, Inputs Figure 5. Undervoltage Lockout Behavior, MAX2216\_E/F, Inputs Set to Low Set to Low*

<span id="page-18-2"></span>

#### **Safety Limit**

Damage to the IC can result in a low-resistance path to ground or to the supply and, without current limiting, the MAX22163−MAX22166 can dissipate excessive amounts of power. Excessive power dissipation can damage the die and thus the isolation barrier, potentially causing downstream issues. *[Table 3](#page-19-0)* shows the safety limits for the MAX22163−MAX22166.

The maximum safety temperature ( $T<sub>S</sub>$ ) for the device is the 150°C maximum junction temperature specified in the *[Absolute Maximum Ratings](#page-1-0)*. The power dissipation (PD) and junction-to-ambient thermal impedance (θJA) determine the junction temperature. Thermal impedance values (θJA and θJC) are available in the *Package Information* section and power dissipation calculations are discussed in the *[Calculating Power Dissipation](#page-20-0)* section. Calculate the junction temperature  $(T_J)$  as:

$$
T_J = T_A + (P_D \times \theta_{JA})
$$

*[Figure 6](#page-19-1)* shows the thermal derating curve for safety limiting the power of the devices, and *[Figure 7](#page-19-2)* shows the thermal derating curve for safety limiting the current of the devices. Ensure the junction temperature does not exceed 150°C.



<span id="page-19-2"></span>

<span id="page-19-1"></span>*Figure 6. Thermal Derating Curve for Safety Power Limiting Figure 7. Thermal Derating Curve for Safety Current Limiting*

## <span id="page-19-0"></span>**Table 3. Safety Limiting Values**



### **Applications Information**

#### **Power-Supply Sequencing**

The MAX22163−MAX22166 do not require any special power supply sequencing. The logic levels are set independently on either side by V<sub>DDA</sub> and V<sub>DDB</sub>. Each supply can be present over the entire specified range regardless of the level or presence of the other supply.

#### **Power-Supply Decoupling**

To reduce ripple and the chance of introducing data errors, bypass  $V_{DDA}$  and  $V_{DDB}$  with 0.1µF low-ESR ceramic capacitors to GNDA and GNDB, respectively. Place the bypass capacitors as close to the power supply input pins as possible.

#### **Layout Considerations**

The PCB designer should follow some critical recommendations to get the best performance from the design.

- Keep the input/output traces as short as possible. To keep signal paths low-inductance, avoid using vias.
- Have a solid ground plane underneath the high-speed signal layer.
- Keep the area underneath the devices free from ground and signal planes. Any galvanic or metallic connection between Side A and Side B defeats the isolation.

#### <span id="page-20-0"></span>**Calculating Power Dissipation**

The required current for a given supply (V<sub>DDA</sub> or V<sub>DDB</sub>) can be estimated by summing the current required for each channel. The supply current for a channel depends on if the channel is an input or an output, the channel's data rate, and the capacitive or resistive load if it is an output. The typical current for an input or output at any data rate can be estimated from the graphs in *[Figure 8](#page-21-0)* and *[Figure 9](#page-21-1)*. Note that the data in *[Figure 8](#page-21-0)* and *[Figure 9](#page-21-1)* are extrapolated from the supply current measurements in a typical operating condition.

The total current for a single channel is the sum of the no load current (shown in *[Figure 8](#page-21-0)* and *[Figure 9](#page-21-1)*), which is a function of voltage and data rate, and the load current, which depends on the type of load. Current into a capacitive load is a function of the load capacitance, switching frequency, and supply voltage.

$$
I_{CL} = C_L \times f_{SW} \times V_{DD}
$$

where:

 $I_{\text{Cl}}$  is the current required to drive the capacitive load.

 $C_1$  is the load capacitance on the isolator's output pin.

 $f_{SW}$  is the switching frequency (bits per second/2).

 $V_{\text{DD}}$  is the supply voltage on the output side of the isolator.

Current into a resistive load depends on the load resistance, supply voltage, and average duty cycle of the data waveform. The DC load current can be conservatively estimated by assuming the output is always high.

$$
I_{RL} = V_{DD} \div R_L
$$

where:

 $I_{RI}$  is the current required to drive the resistive load.

 $V<sub>DD</sub>$  is the supply voltage on the output side of the isolator.

 $R<sub>l</sub>$  is the load resistance on the isolator's output pin.

**Example** (shown in *[Figure 10](#page-22-0)*): A MAX22164C is operating with V<sub>DDA</sub> = 2.5V, V<sub>DDB</sub> = 3.3V, channel 1 operating at 20Mbps with a 15kΩ resistive load; channel 2 operating at 100Mbps with a 10pF capacitive load; channel 3 is not in use and the resistive load is negligible as the isolator is driving a CMOS input; channel 4 held high with a 10kΩ resistive load; channel 5 operating at 50Mbps with a 20kΩ resistive load; and channel 6 operating at 200Mbps with a 15pF capacitive load. See **[Table 4](#page-23-0)** and **[Table 5](#page-23-1)** for V<sub>DDA</sub> and V<sub>DDB</sub> supply current calculation worksheets.

#### **V**<sub>DDA</sub> must supply (with  $V_{DDA}$  = 2.5V):

- Channel 1 is an input channel operating at 2.5V and 20Mbps, consuming 0.35mA, estimated from *[Figure 8](#page-21-0)*.
- Channel 2 is an input channel operating at 2.5V and 100Mbps, consuming 1.19mA, estimated from *[Figure 8](#page-21-0)*.
- Channels 3 and 4 are input channels operating at 2.5V with DC signal, consuming 0.14mA, estimated from *[Figure 8](#page-21-0)*.
- Channel 5 is an output channel operating at 2.5V and 50Mbps, consuming 0.52mA, estimated from *[Figure 9](#page-21-1)*.
- IRL on channel 5 for 20kΩ resistive load at 2.5V and switching at 50Mbps with 50% duty cycle is 0.0625mA.
- Channel 6 is an output channel operating at 2.5V and 200Mbps, consuming 1.31mA, estimated from *[Figure 9](#page-21-1)*.
- $I_{\text{Cl}}$  on channel 6 for 15pF capacitive load at 2.5V and 200Mbps is 3.75mA.
- Total current for Side  $A = 7.46$ mA (typ).

#### $V_{\text{DDB}}$  must supply (with  $V_{\text{DDB}}$  = 3.3V):

- Channel 1 is an output channel operating at 3.3V and 20Mbps, consuming 0.40mA, estimated from *[Figure 9](#page-21-1)*.
- IRL on channel 1 for 15kΩ resistive load at 3.3V and switching at 20Mbps with 50% duty cycle is 0.11mA.
- Channel 2 is an output channel operating at 3.3V and 100Mbps, consuming 0.96mA, estimated from *[Figure 9](#page-21-1)*.
- $I_{\text{Cl}}$  on channel 2 for 10pF capacitive load at 3.3V and 100Mbps is 1.65mA.
- Channels 3 and 4 are output channels operating at 3.3V with DC signal, consuming 0.26mA, estimated from *[Figure](#page-21-1)  [9](#page-21-1)*.
- I<sub>RI</sub> on channel 4 for 10kΩ resistive load held at 3.3V is 0.33mA.
- Channel 5 is an input channel operating at 3.3V and 50Mbps, consuming 0.68mA, estimated from *[Figure 8](#page-21-0)*.

• Channel 6 is an input channel operating at 3.3V and 200Mbps, consuming 2.29mA, estimated from *[Figure 8](#page-21-0)*. Total current for Side  $B = 6.94 \text{mA}$  (typ).



<span id="page-21-1"></span>

<span id="page-21-0"></span>*Figure 8. Supply Current Per Input Channel (Calculated) Figure 9. Supply Current Per Output Channel (Calculated)*



<span id="page-22-0"></span>*Figure 10. Example Circuit for Supply Current Calculation*



# <span id="page-23-0"></span>**Table 4. Side A Supply Current Calculation Worksheet**

# <span id="page-23-1"></span>**Table 5. Side B Supply Current Calculation Worksheet**



# **Typical Application Circuits**



## **Product Selector Guide**



## **Ordering Information**

<span id="page-25-0"></span>



*\*Future product − contact Analog Devices for availability.*

*+Denotes a lead (Pb)–free/RoHS-compliant package.*

*/V Denotes an automotive qualified part.*

### **Chip Information**

PROCESS: BiCMOS

### **Revision History**





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